



勝特力材料 886-3-5753170  
 勝特力电子(上海) 86-21-34970699  
 勝特力电子(深圳) 86-755-83298787  
 Http://www.100y.com.tw

**IRFZ20, SiHFZ20**

Vishay Siliconix

## Power MOSFET

PRODUCT SUMMARY	
$V_{DS}$ (V)	50
$R_{DS(on)}$ ( $\Omega$ )	$V_{GS} = 10\text{ V}$ 0.10
$Q_g$ (Max.) (nC)	17
$Q_{gs}$ (nC)	9.0
$Q_{gd}$ (nC)	3.0
Configuration	Single

### FEATURES

- Extremely Low  $R_{DS(on)}$
- Compact Plastic Package
- Fast Switching
- Low Drive Current
- Ease of Paralleling
- Excellent Temperature Stability
- Parts Per Million Quality
- Compliant to RoHS Directive 2002/95/EC



Available  
**RoHS\***  
 COMPLIANT

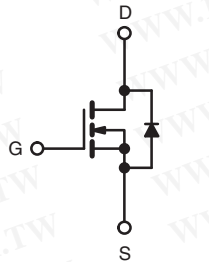
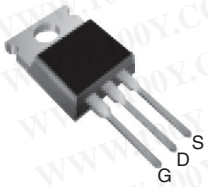
### DESCRIPTION

The technology has expanded its product base to serve the low voltage, very low  $R_{DS(on)}$  MOSFET transistor requirements. Vishay's highly efficient geometry and unique processing have been combined to create the lowest on resistance per device performance. In addition to this feature all have documented reliability and parts per million quality!

The transistor also offer all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling, and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and in systems that are operated from low voltage batteries, such as automotive, portable equipment, etc.

TO-220AB



N-Channel MOSFET

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ20PbF SiHFZ20-E3
SnPb	IRFZ20 SiHFZ20

ABSOLUTE MAXIMUM RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage <sup>a</sup>		$V_{DS}$	50	V	
Gate-Source Voltage <sup>a</sup>		$V_{GS}$	$\pm 20$	V	
Continuous Drain Current	$V_{GS}$ at 10 V	$I_D$	$T_C = 25\text{ }^\circ\text{C}$	15	A
			$T_C = 100\text{ }^\circ\text{C}$	10	
Pulsed Drain Current <sup>b</sup>		$I_{DM}$	60		
Single Pulse Avalanche Energy <sup>c</sup>		$E_{AS}$	5	mJ	
Linear Derating Factor (see fig. 16)			0.32	W/ $^\circ\text{C}$	
Maximum Power Dissipation (see fig. 16)	$T_C = 25\text{ }^\circ\text{C}$	$P_D$	40	W	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	- 55 to + 150	$^\circ\text{C}$	
Soldering Recommendations (Peak Temperature)	for 10 s		300 (0.063" (1.6 mm) from case)		

#### Notes

- $T_J = 25\text{ }^\circ\text{C}$  to  $150\text{ }^\circ\text{C}$
- Repetitive rating: Pulse width limited by max. junction temperature. See transient temperature impedance curve (see fig. 11).
- Starting  $T_J = 25\text{ }^\circ\text{C}$ ,  $L = 0.07\text{ mH}$ ,  $R_g = 25\text{ }^\circ\Omega$ ,  $I_{AS} = 12\text{ A}$

\* Pb containing terminations are not RoHS compliant, exemptions may apply

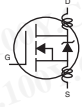

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Typical Socket Mount, Junction-to-Ambient	$R_{thJA}$	-	80	°C/W
Case-to-Sink, Mounting Surface Flat, Smooth, and Greased	$R_{thCS}$	1.0	-	
Junction-to-Case	$R_{thJC}$	-	3.12	

ELECTRICAL CHARACTERISTICS ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	50	-	-	V
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2.0	-	4.0	V
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20\text{ V}$	-	-	$\pm 500$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} > \text{Max. Rating}, V_{GS} = 0\text{ V}$	-	-	250	$\mu\text{A}$
		$V_{DS} = \text{Max. Rating} \times 0.8, V_{GS} = 0\text{ V}, T_C = 125\text{ }^\circ\text{C}$	-	-	1000	
On-State Drain Current	$I_{D(on)}$	$V_{GS} = 10\text{ V}, V_{DS} > I_{D(on)} \times R_{DS(on)} \text{ max.}$	-	-	15	A
Drain-Source On-State Resistance <sup>b</sup>	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 10\text{ A}$	-	0.080	0.10	$\Omega$
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} > I_{D(on)} \times R_{DS(on)} \text{ max.}, I_D = 9.0\text{ A}$	5.0	6.0	-	S
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1.0\text{ MHz}, \text{ see fig. 11}$	-	560	860	pF
Output Capacitance	$C_{oss}$		-	250	350	
Reverse Transfer Capacitance	$C_{rss}$		-	60	100	
Total Gate Charge	$Q_g$	$V_{GS} = 10\text{ V}, I_D = 20\text{ A}, V_{DS} = 0.8 \text{ max. rating, see fig. 18 for test circuit (Gate charge is essentially independent of operating temperature)}$	-	12	17	nC
Gate-Source Charge	$Q_{gs}$		-	9.0	-	
Gate-Drain Charge	$Q_{gd}$		-	3.0	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 25\text{ V}, I_D = 9.0\text{ A}, Z_0 = 50\text{ }\Omega, \text{ see fig. 5}^b$	-	15	30	ns
Rise Time	$t_r$		-	45	90	
Turn-Off Delay Time	$t_{d(off)}$		-	20	40	
Fall Time	$t_f$		-	15	30	
Internal Drain Inductance	$L_D$	Modified MOSFET symbol showing the internal device inductances 	-	3.5	-	nH
Internal Source Inductance	$L_S$		-	4.5	-	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction rectifier 	-	-	15	A
Pulsed Diode Forward Current <sup>a</sup>	$I_{SM}$		-	-	60	
Body Diode Voltage <sup>b</sup>	$V_{SD}$	$T_C = 25\text{ }^\circ\text{C}, I_S = 15\text{ A}, V_{GS} = 0\text{ V}$	-	-	1.5	V
Body Diode Reverse Recovery Time	$t_{rr}$	$T_J = 150\text{ }^\circ\text{C}, I_F = 15\text{ A}, dI_F/dt = 100\text{ A}/\mu\text{s}$	-	100	-	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$		-	0.4	-	$\mu\text{C}$
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )				

## Notes

- Repetitive rating: Pulse width limited by max. junction temperature. See transient temperature impedance curve (see fig. 5).
- Pulse test: Pulse width  $\leq 300\text{ }\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

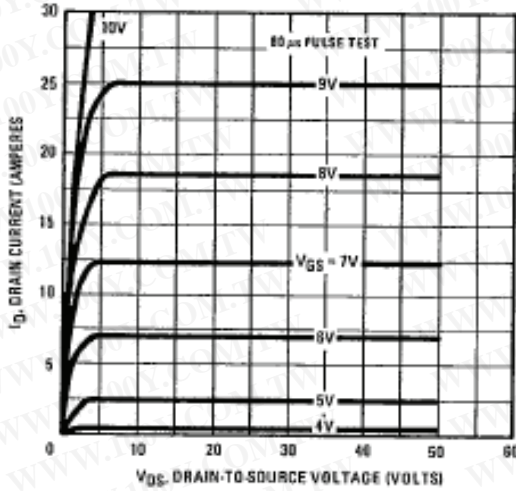


Fig. 1 - Typical Output Characteristics

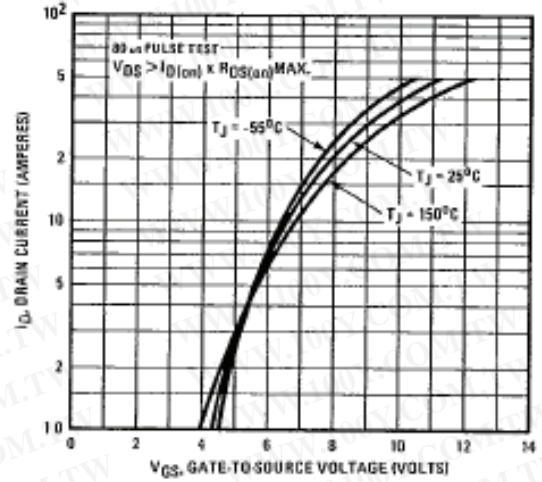


Fig. 3 - Typical Transfer Characteristics

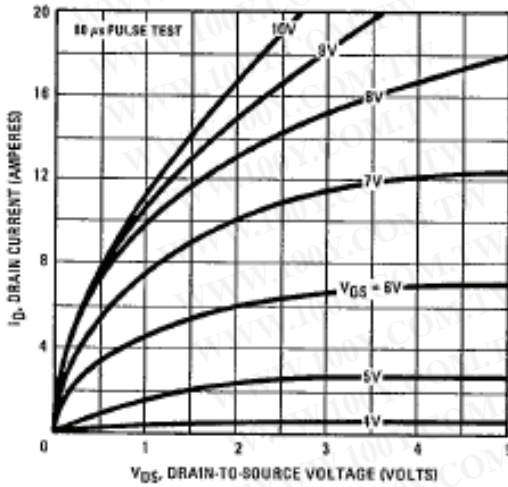


Fig. 2 - Typical Saturation Characteristics

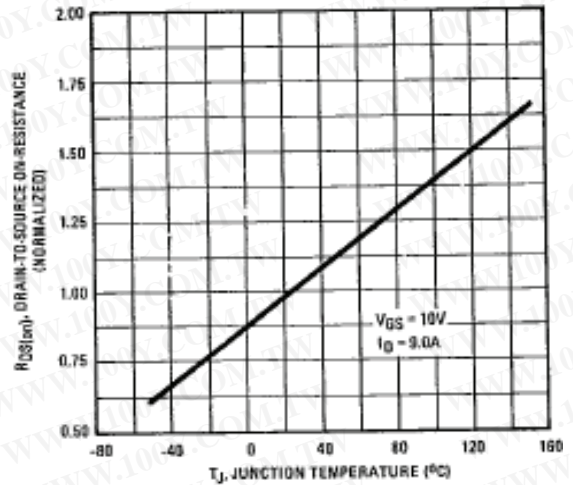


Fig. 4 - Normalized On-Resistance vs. Temperature

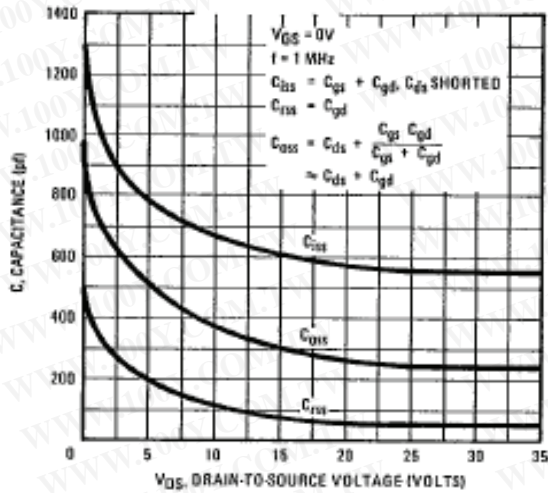


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

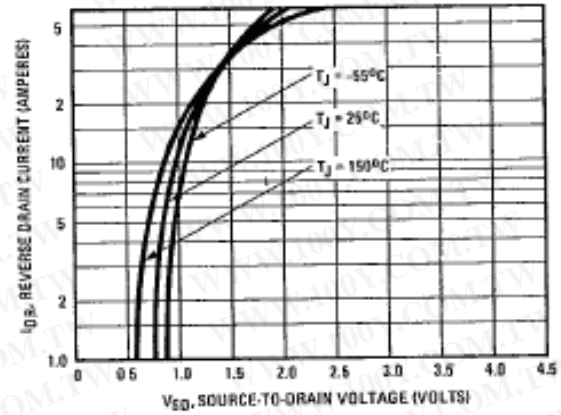


Fig. 7 - Typical Source-Drain Diode Forward Voltage

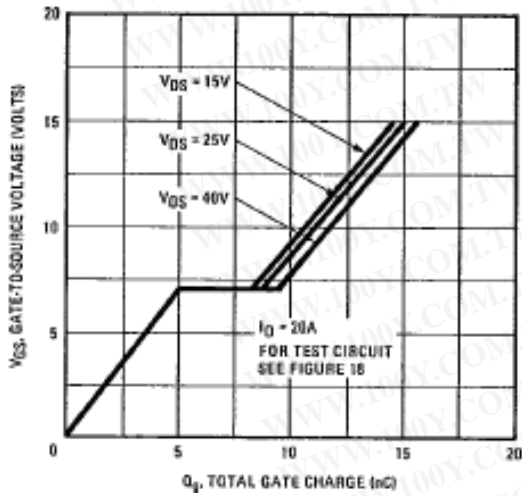


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

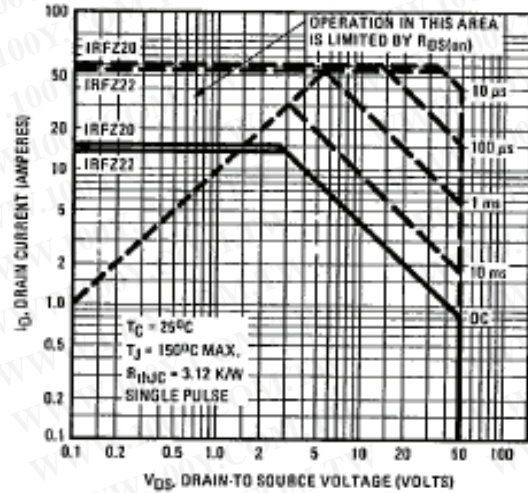


Fig. 8 - Maximum Safe Operating Area

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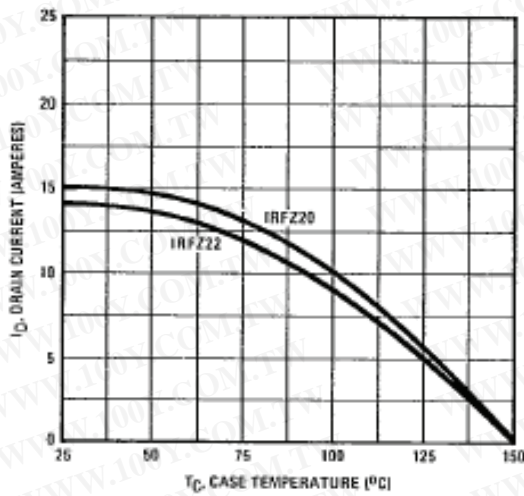


Fig. 9 - Maximum Drain Current vs. Case Temperature

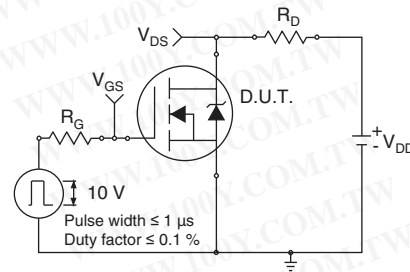


Fig. 10a - Switching Time Test Circuit

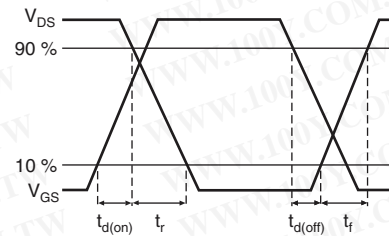


Fig. 10b - Switching Time Waveforms

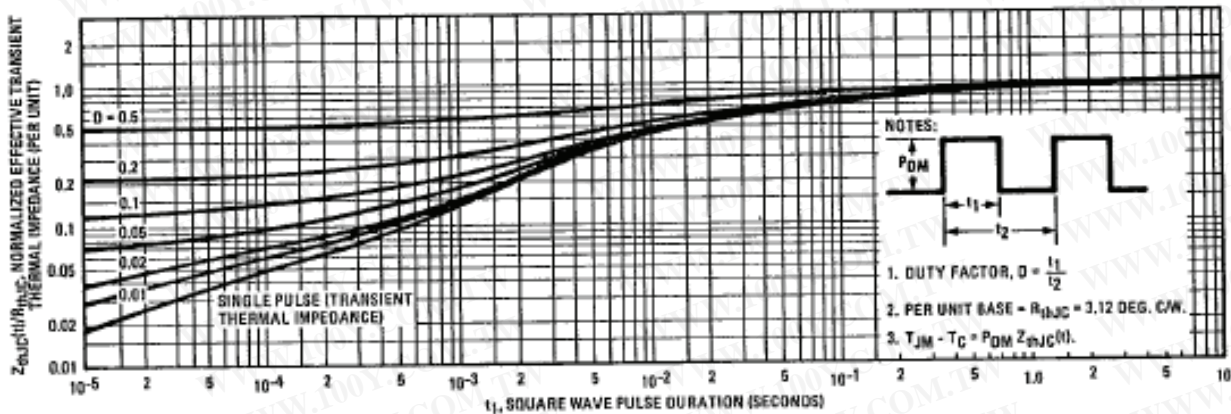


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case vs. Pulse Duration

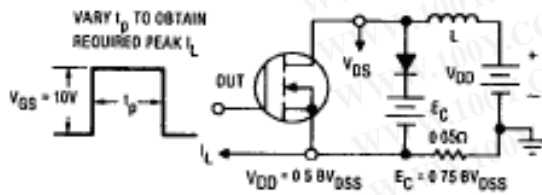


Fig. 12a - Clamped Inductive Test Circuit

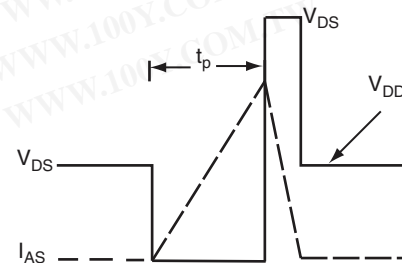


Fig. 12b - Unclamped Inductive Waveforms

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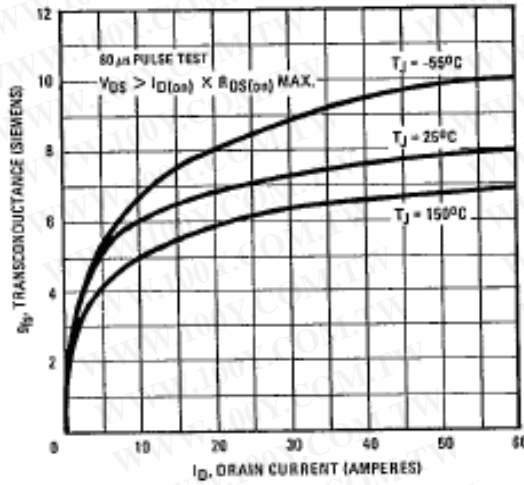


Fig. 13 - Typical Transconductance vs. Drain Current

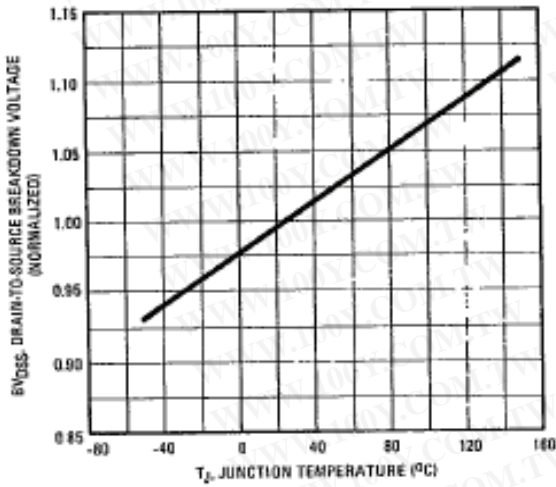


Fig. 14 - Breakdown Voltage vs. Temperature

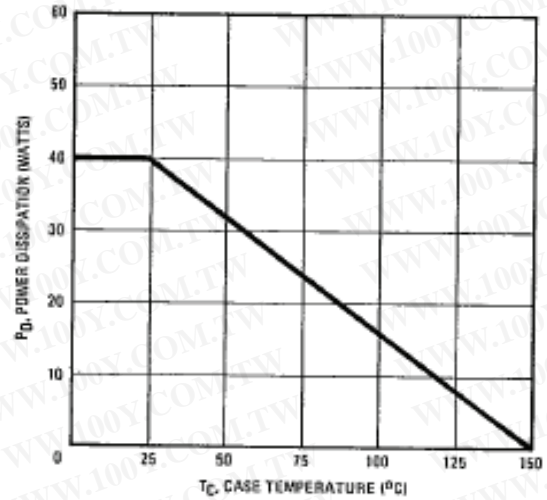


Fig. 16 - Power vs. Temperature Derating Curve

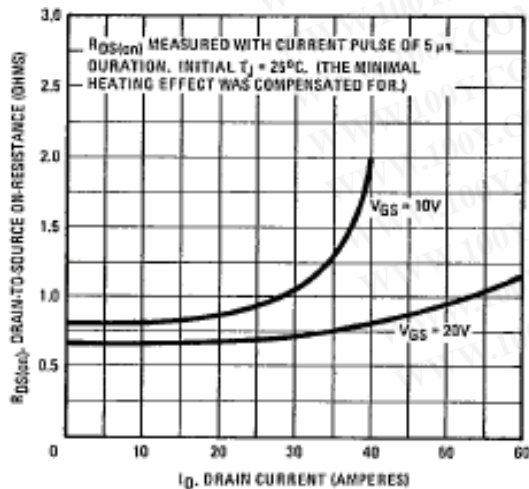


Fig. 15 - Typical On-Resistance vs. Drain Current

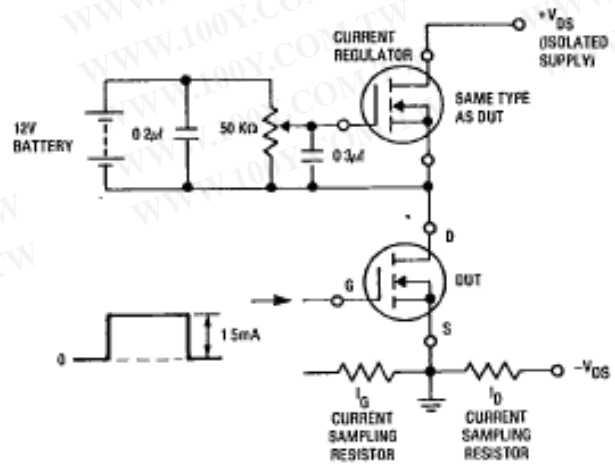
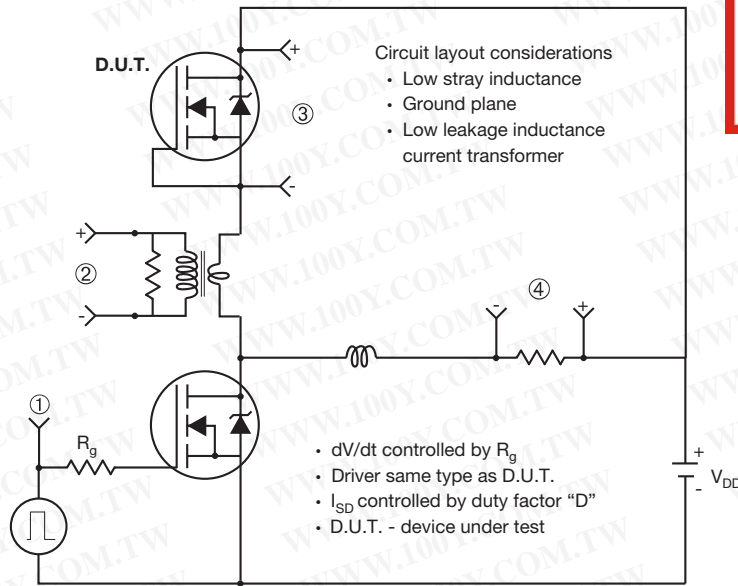
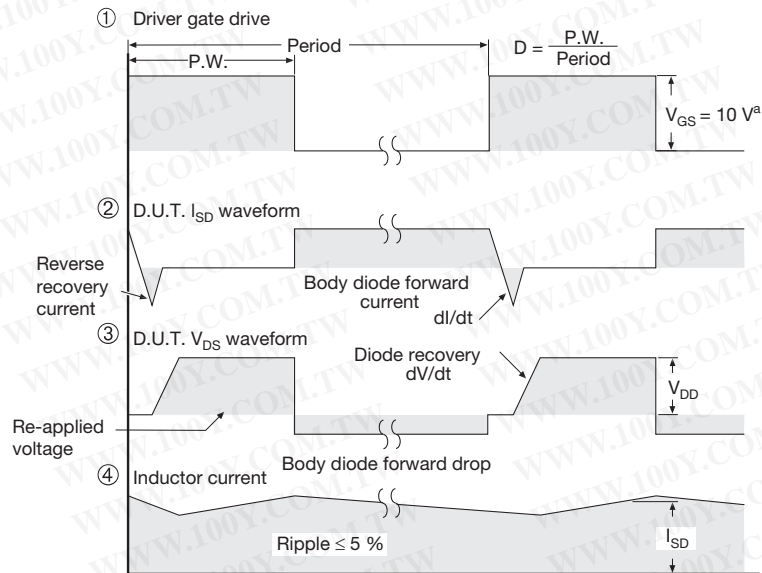


Fig. 17 - Gate Charge Test Circuit

### Peak Diode Recovery $dV/dt$ Test Circuit



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**Note**  
 a.  $V_{GS} = 5\text{ V}$  for logic level devices

**Fig. 14 - For N-Channel**

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <http://www.vishay.com/ppg?91340>.



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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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